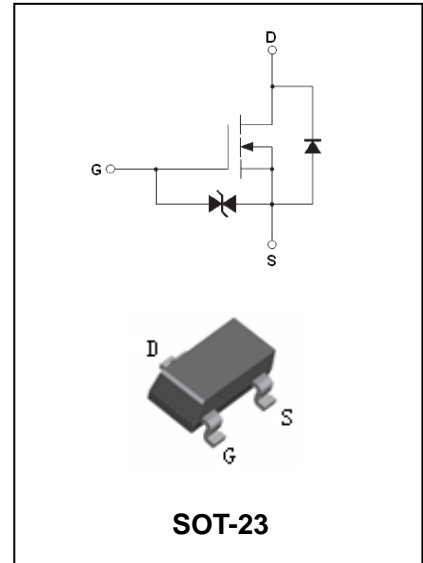


N-Channel Enhancement Mode Field Effect Transistor **2SK3018**

FEATURES

- Low on-resistance.
- Fast switching speed.
- Low voltage drive(2.5V)makes this Device ideal for portable equipment.
- Easily designed drive circuits.
- Easy to parallel.

HF



APPLICATIONS

- Interfacing,switching (30V,100mA)

ORDERING INFORMATION

Type No.	Marking	Package Code
2SK3018	KN	SOT-23

MAXIMUM RATING @ Ta=25°C unless otherwise specified

Symbol	Parameter		Value	Units
V_{DSS}	Drain-Source voltage		30	V
V_{GSS}	Gate -Source voltage		± 20	V
I_D I_{DP}^{*1}	drain current	Continuous Pulsed	100 200	mA
I_{DR} I_{DRP}^{*1}	Reverse drain current	Continuous Pulsed	100 200	mA
P_D^{*2}	Total Power Dissipation($T_C=25^\circ C$)		200	mW
T_{ch}, T_{stg}	Channel and Storage Temperature		-55 to +150	$^\circ C$

*1 $P_w \leq 10\mu s$, Duty cycles $\leq 50\%$

*2With each pin mounted on the recommended lands.

N-Channel Enhancement Mode Field Effect Transistor **2SK3018**

ELECTRICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

Parameter	Symbol	Test conditions	MIN	TYP	MAX	UNIT
Gate- Source Leakage	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 1	μA
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=10\mu A$	30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=3V, I_D=100\mu A$	0.8		1.5	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30V, V_{GS}=0V$			1	μA
Static drain-source on-state resistance	$R_{DS(on)}$	$I_D=10mA, V_{GS}=4V$		5	8	Ω
	$R_{DS(on)}$	$I_D=1mA, V_{GS}=2.5V$		7	13	Ω
Diode Forward Voltage	V_{SD}	$I_S=0.3A, V_{GS}=0V$		0.9	1.4	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS}=3V, I_D=10mA$	20			mS
Input capacitance	C_{ISS}	$V_{DS}=5V, V_{GS}=0V, f=1.0MHz$		13		pF
Output capacitance	C_{OSS}			9		
Reverse transfer capacitance	C_{RSS}			4		
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD} = 5V, I_D= 10mA,$ $R_L = 500\Omega, V_{GS}= 5V,$ $R_{GEN}= 10\Omega$		15		ns
Rise time	t_r			35		ns
Turn-Off Delay Time	$t_{D(OFF)}$			80		ns
Fall time	T_f			80		ns

TYPICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

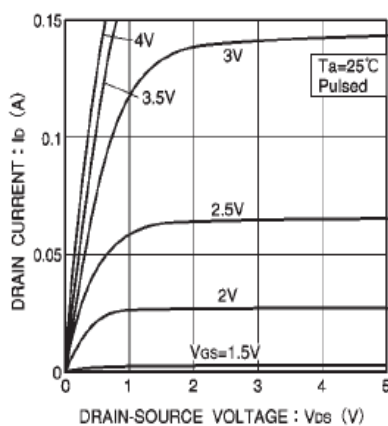


Fig.1 Typical output characteristics

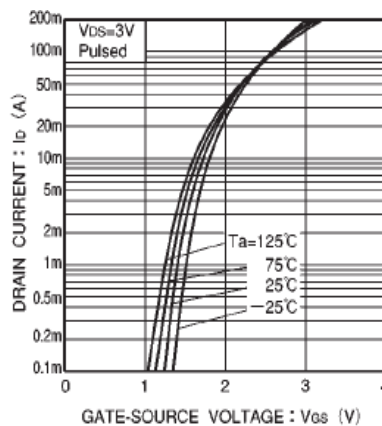


Fig.2 Typical transfer characteristics

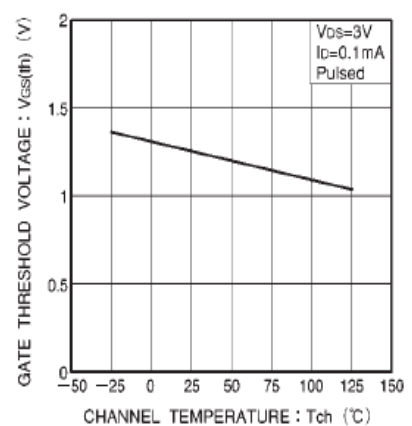


Fig.3 Gate threshold voltage vs. channel temperature

N-Channel Enhancement Mode Field Effect Transistor **2SK3018**

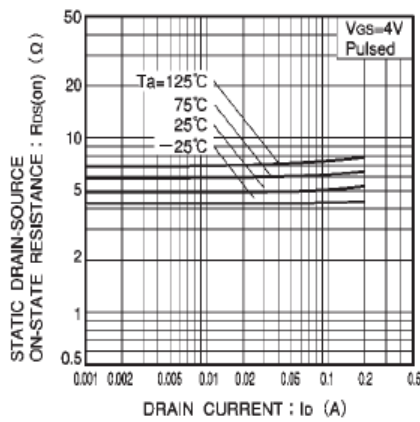


Fig.4 Static drain-source on-state resistance vs. drain current (I)

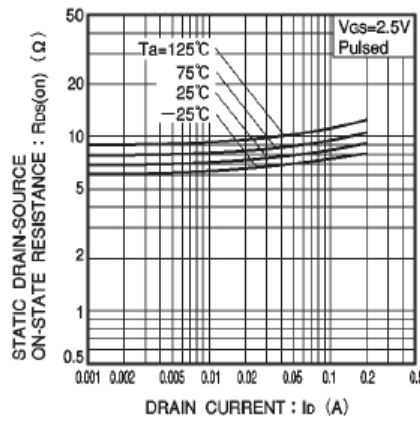


Fig.5 Static drain-source on-state resistance vs. drain current (II)

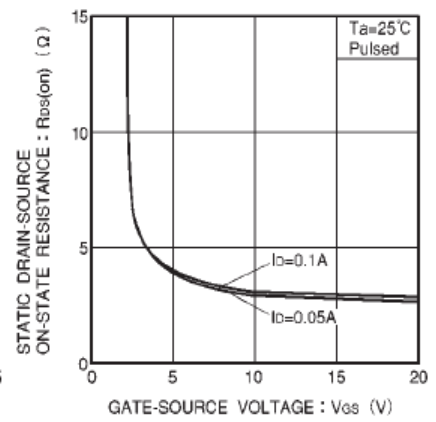


Fig.6 Static drain-source on-state resistance vs. gate-source voltage

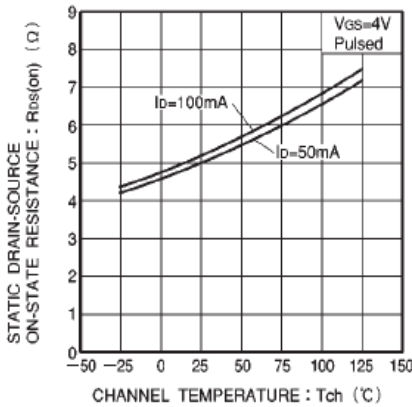


Fig.7 Static drain-source on-state resistance vs. channel temperature

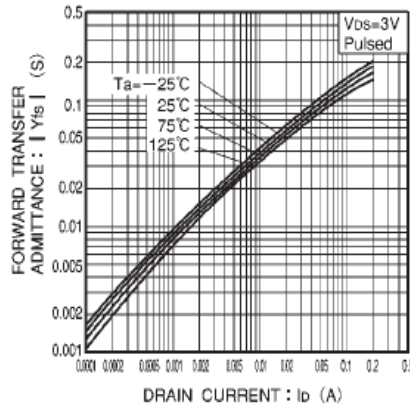


Fig.8 Forward transfer admittance vs. drain current

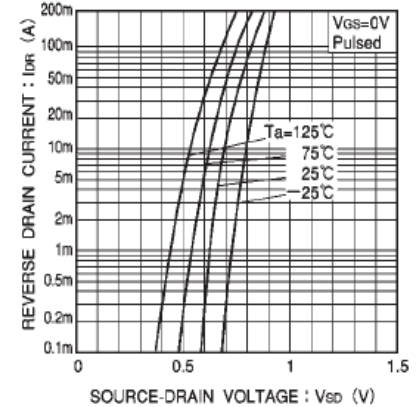


Fig.9 Reverse drain current vs. source-drain voltage (I)

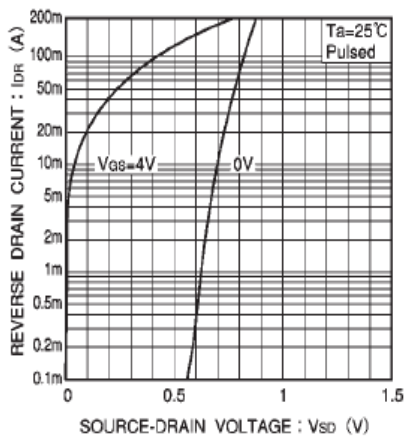


Fig.10 Reverse drain current vs. source-drain voltage (II)

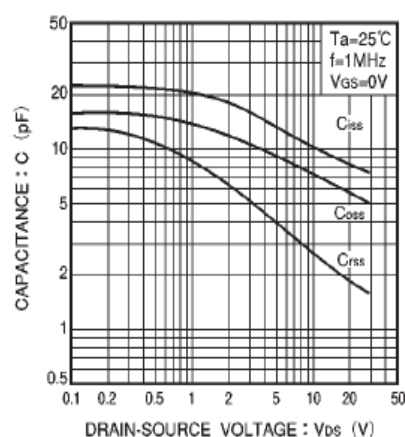


Fig.11 Typical capacitance vs. drain-source voltage

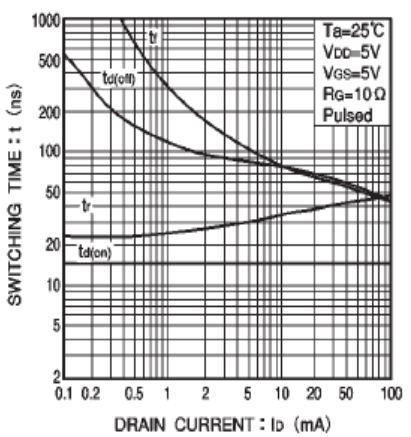


Fig.12 Switching characteristics (See Figures. 13 and 14 for the measurement circuit and resultant waveforms)

N-Channel Enhancement Mode Field Effect Transistor **2SK3018**

Switching characteristics measurement circuit

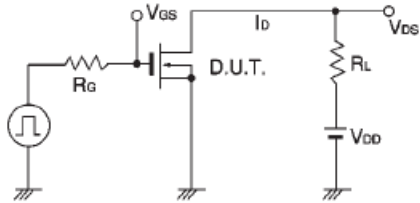


Fig.13 Switching time measurement circuit

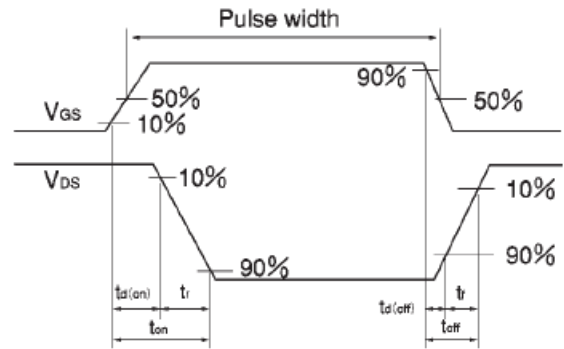


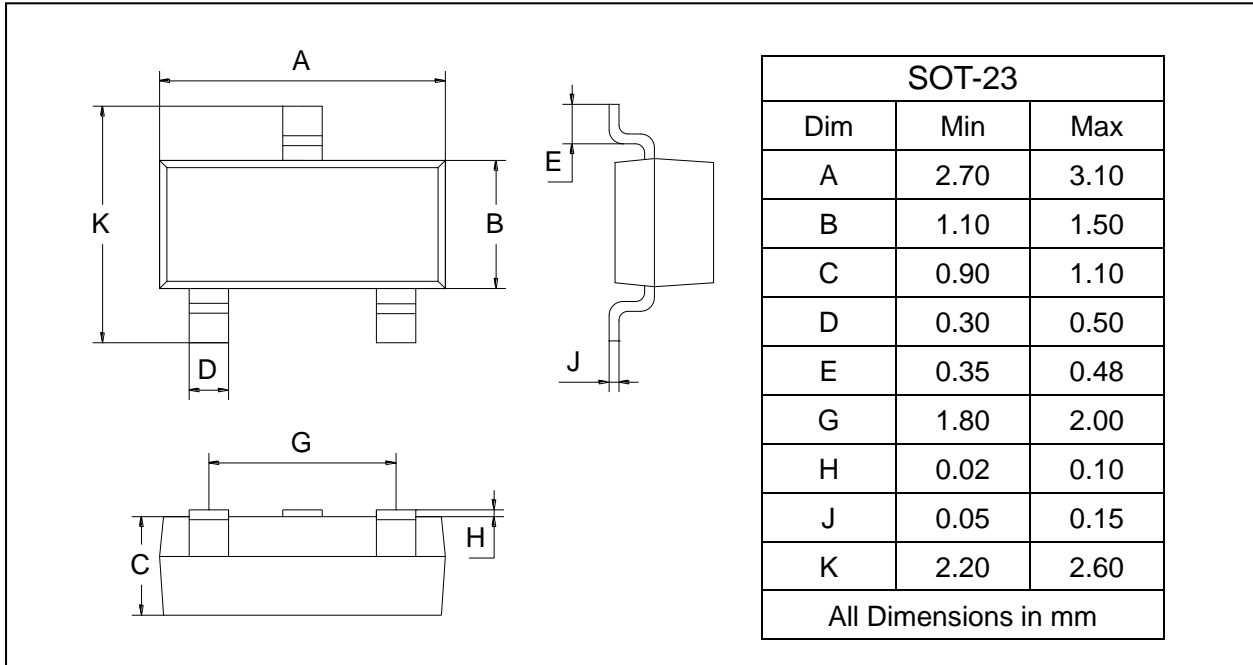
Fig.14 Switching time waveforms

N-Channel Enhancement Mode Field Effect Transistor **2SK3018**

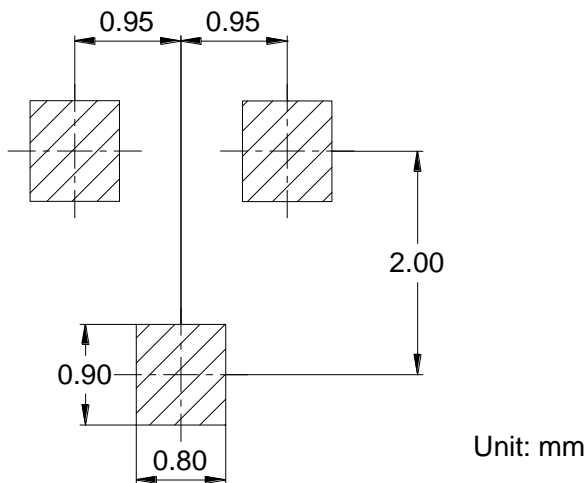
PACKAGE OUTLINE

Plastic surface mounted package

SOT-23



SOLDERING FOOTPRINT



PACKAGE INFORMATION

Device	Package	Shipping
2SK3018	SOT-23	3000 pcs / Tape & Reel